

## 120A, 85V N-CHANNEL MOSFET

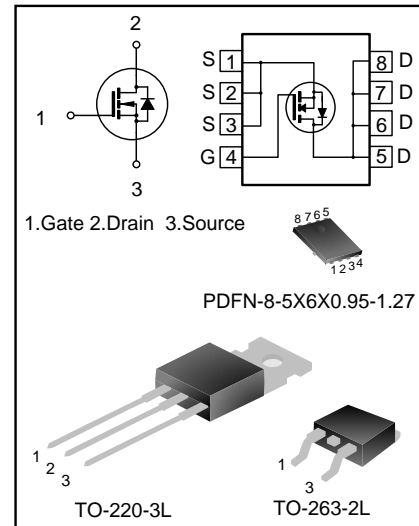
### DESCRIPTION

The SVT085R5NT/S/L5 is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan's LVMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance.

This device is widely used in the fields of uninterruptible power supplies and power management of inverter systems.

### FEATURES

- ◆ 120A, 85V,  $R_{DS(on)(typ.)}=4.5m\Omega @ V_{GS}=10V$
- ◆ Low gate charge
- ◆ Low Crss
- ◆ Fast switching
- ◆ Improved dv/dt capability



### ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVT085R5NT	TO-220-3L	085R5NT	Pb free	Tube
SVT085R5NS	TO-263-2L	085R5NS	Halogen free	Tube
SVT085R5NSTR	TO-263-2L	085R5NS	Halogen free	Tape&Reel
SVT085R5NL5TR	PDFN-8-5X6X0.95-1.27	085R5NL5	Halogen free	Tape&Reel

### ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, $T_C=25^\circ C$ )

Characteristics	Symbol	Ratings		Unit	
		SVT085R5NT/S	SVT085R5NL5		
Drain-Source Voltage	$V_{DS}$	85		V	
Gate-Source Voltage	$V_{GS}$	$\pm 20$		V	
Drain Current	$I_D$	$T_C=25^\circ C$	120	100	A
		$T_C=100^\circ C$	90	64	
Drain Current Pulsed	$I_{DM}$	480	400	A	
Power Dissipation ( $T_C=25^\circ C$ ) -Derate above $25^\circ C$	$P_D$	160	114	W	
		1.3	0.9	W/ $^\circ C$	
Single Pulsed Avalanche Energy (Note 1)	$E_{AS}$	324		mJ	
Operation Junction Temperature Range	$T_J$	-55~+150		$^\circ C$	
Storage Temperature Range	$T_{stg}$	-55~+150		$^\circ C$	

## THERMAL CHARACTERISTICS

Characteristics	Symbol	Ratings		Unit
		SVT085R5NT/S	SVT085R5NL5	
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.78	1.1	$^{\circ}C/W$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	50	$^{\circ}C/W$

## ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED, $T_C=25^{\circ}C$ )

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	85	--	--	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=85V, V_{GS}=0V$	--	--	1.0	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	--	--	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	2.0	--	4.0	V
Static Drain- Source On State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=50A$	--	4.5	5.5	m $\Omega$
Gate Resistance	$R_G$	f=1MHz	--	1.9	--	$\Omega$
Input Capacitance	$C_{iss}$	f=1MHz, $V_{GS}=0V,$ $V_{DS}=40V$	--	4281	--	pF
Output Capacitance	$C_{oss}$		--	669	--	
Reverse Transfer Capacitance	$C_{rss}$		--	17	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=40V, V_{GS}=10V, R_G=24\Omega,$ $I_D=13.3A$ (Notes 2,3)	--	41	--	ns
Turn-on Rise Time	$t_r$		--	68	--	
Turn-off Delay Time	$t_{d(off)}$		--	164	--	
Turn-off Fall Time	$t_f$		--	85	--	
Total Gate Charge	$Q_g$	$V_{DD}=40V, V_{GS}=10V, I_D=50A$ (Notes 2,3)	--	68	--	nC
Gate-Source Charge	$Q_{gs}$		--	28	--	
Gate-Drain Charge	$Q_{gd}$		--	17	--	

## SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	$I_S$	Integral Reverse P-N Junction Diode in the MOSFET	--	--	120	A
Pulsed Source Current	$I_{SM}$		--	--	480	
Diode Forward Voltage	$V_{SD}$	$I_S=50A, V_{GS}=0V$	--	--	1.3	V
Reverse Recovery Time	$T_{rr}$	$I_S=20A, V_{GS}=0V,$	--	59	--	ns
Reverse Recovery Charge	$Q_{rr}$	dI/dt=100A/ $\mu s$ (Notes 2)	--	0.12	--	$\mu C$

Notes:

- $L=0.5mH, I_{AS}=36A, V_{DD}=64V, R_G=10\Omega,$  starting  $T_J=25^{\circ}C$ ;
- Pulse Test: Pulse width  $\leq 300\mu s,$  Duty cycle  $\leq 2\%$ ;
- Essentially independent of operating temperature.

**TYPICAL CHARACTERISTICS**

Figure 1. Output Characteristics

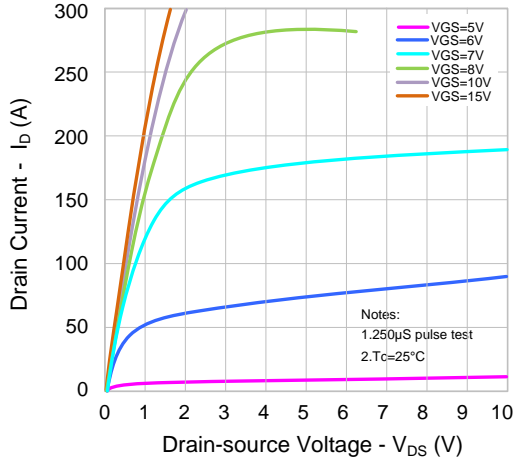


Figure 2. Transfer Characteristics

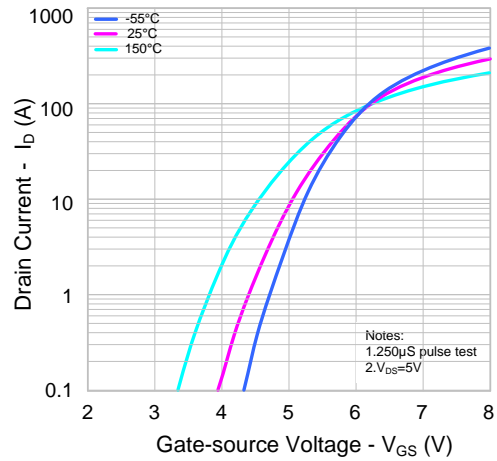


Figure 3. On-resistance vs. Drain Current

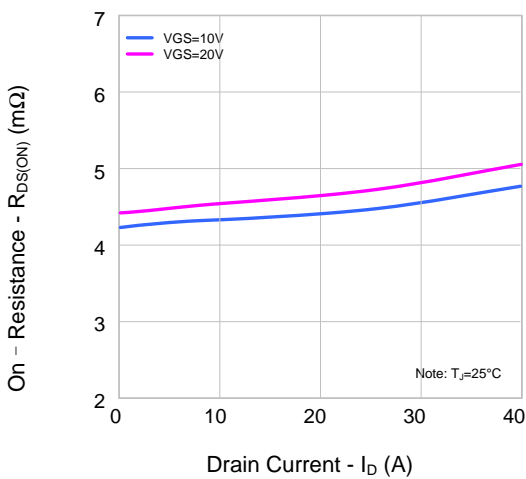


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

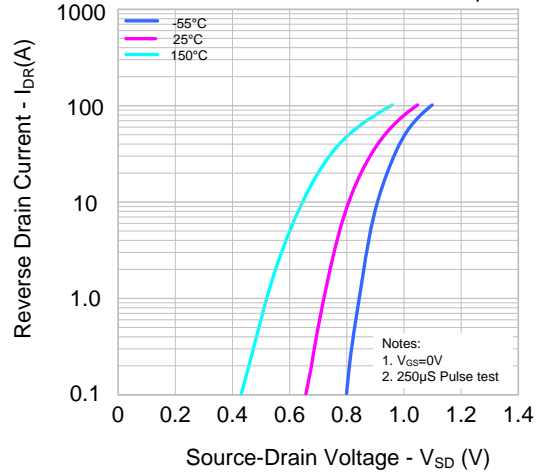


Figure 5. Capacitance Characteristics

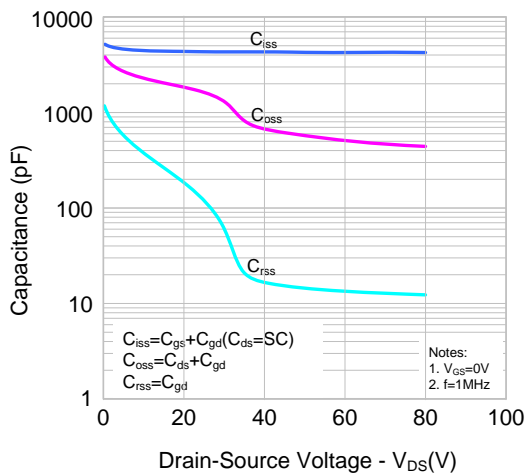
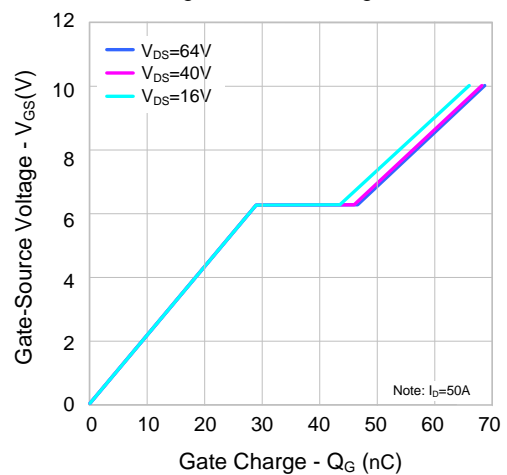


Figure 6. Gate Charge



**TYPICAL CHARACTERISTICS (CONTINUED)**

Figure 7. Breakdown Voltage vs. Temperature Characteristics

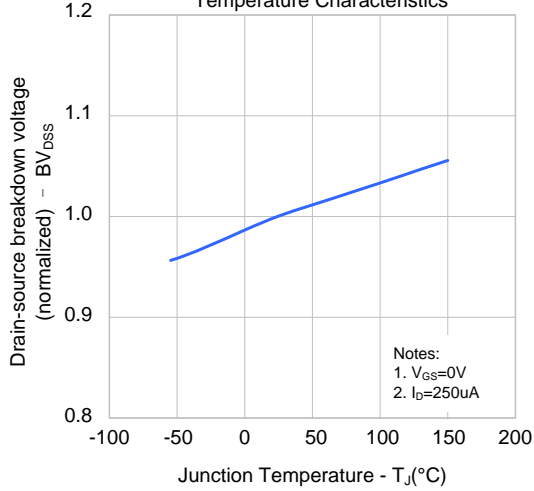


Figure 8. On-resistance vs. Temperature Characteristics

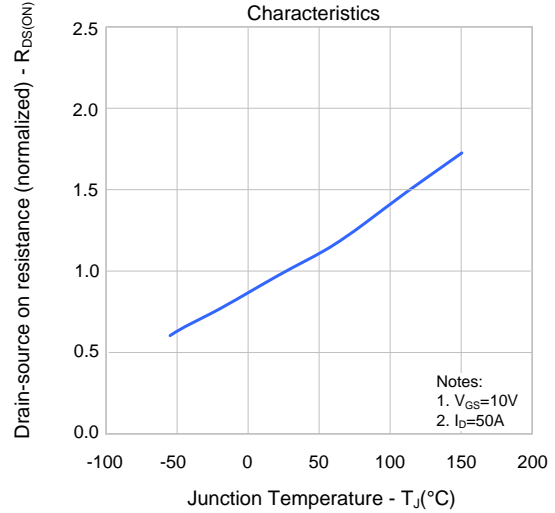


Figure 9-1. Max. Safe Operating Area (SVT085R5NT/S)

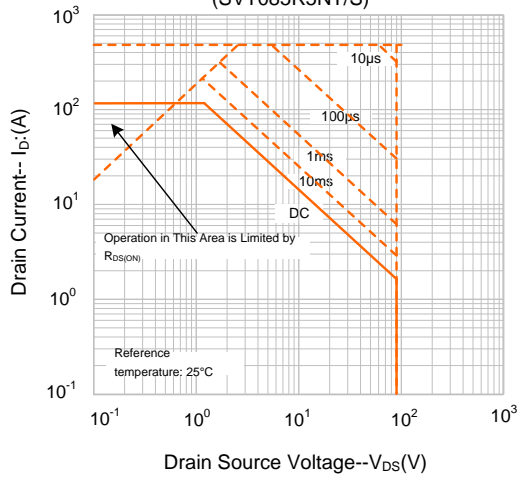
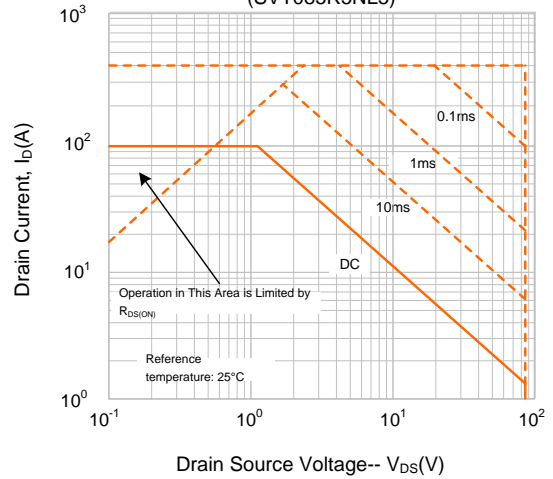
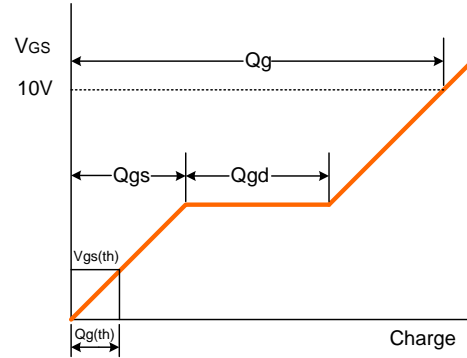
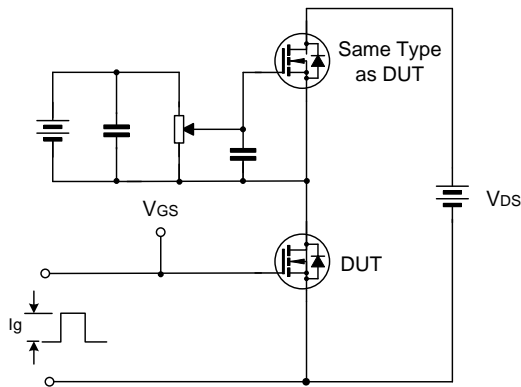


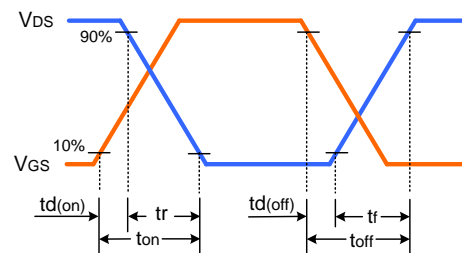
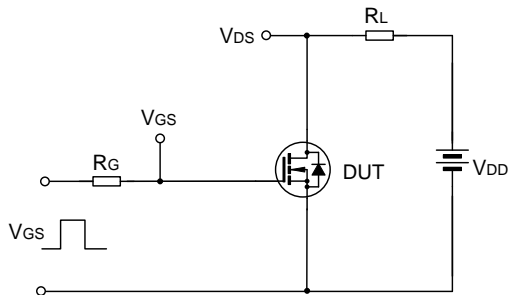
Figure 9-2. Max. Safe Operating Area (SVT085R5NL5)



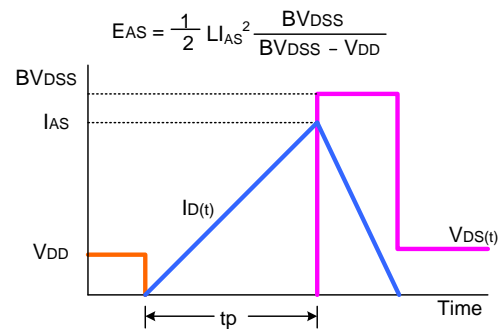
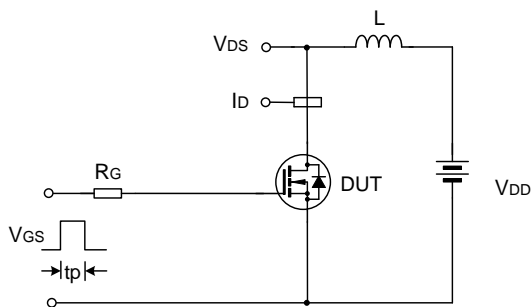
**TYPICAL TEST CIRCUIT**



Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform

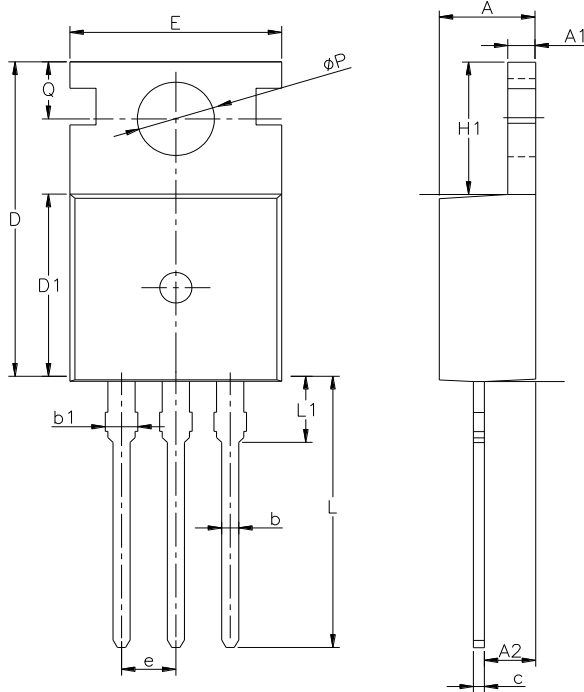


Unclamped Inductive Switching Test Circuit & Waveform

**PACKAGE OUTLINE**

**TO-220-3L**

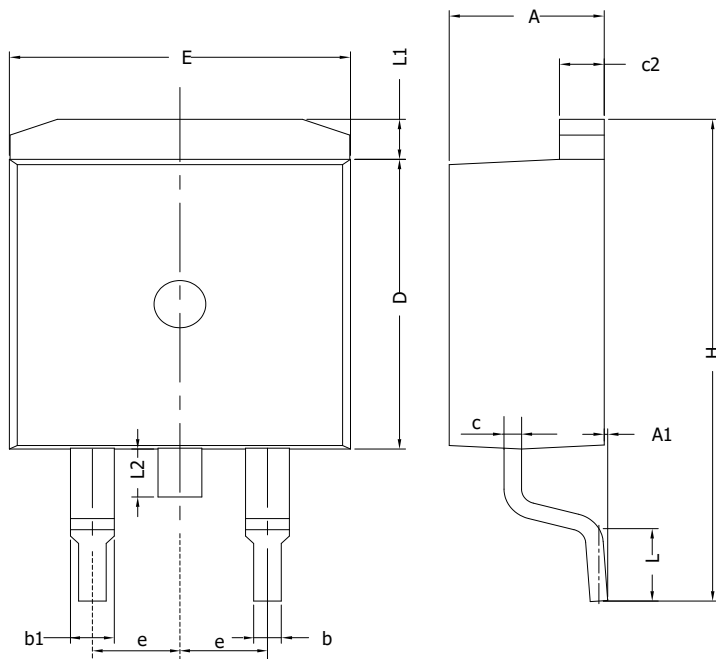
**UNIT: mm**



SYMBOL	MIN	NOM	MAX
A	4.30	4.50	4.70
A1	1.00	1.30	1.50
A2	1.80	2.40	2.80
b	0.60	0.80	1.00
b1	1.00	—	1.60
c	0.30	—	0.70
D	15.10	15.70	16.10
D1	8.10	9.20	10.00
E	9.60	9.90	10.40
e	2.54BSC		
H1	6.10	6.50	7.00
L	12.60	13.08	13.60
L1	—	—	3.95
$\phi P$	3.40	3.70	3.90
Q	2.60	—	3.20

**TO-263-2L**

**UNIT: mm**

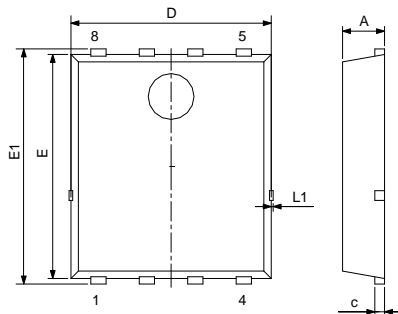


SYMBOL	MIN	NOM	MAX
A	4.30	4.57	4.72
A1	0	0.10	0.25
b	0.71	0.81	0.91
c	0.30	---	0.60
c2	1.17	1.27	1.37
D	8.50	---	9.35
E	9.80	---	10.45
e	2.54BSC		
H	14.70	---	15.75
L	2.00	2.30	2.74
L1	1.12	1.27	1.42
L2	---	---	1.75

**PACKAGE OUTLINE(CONTINUED)**

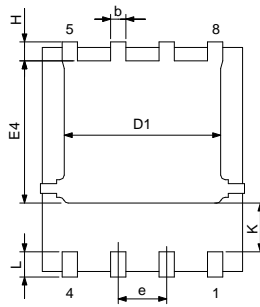
PDFN-8-5X6X0.95-1.27

UNIT: mm

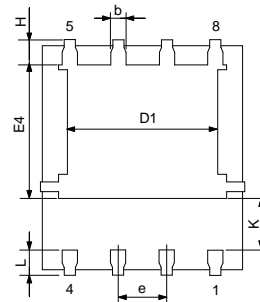


Top View

Side View



Bottom View (X)



Bottom View (N)

SYMBOL	X			N		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.90	1.10	1.30	0.90	0.95	1.00
c	0.154	0.254	0.354	0.21	0.25	0.34
D	4.90	5.20	5.50	4.80	4.90	5.00
E	5.56	5.86	6.16	5.70	5.75	5.80
D1	3.80	4.10	4.30	3.91	4.01	4.11
E1	5.85	6.15	6.45	5.90	6.00	6.10
b	0.20	0.40	0.60	0.35	0.45	0.55
K	1.10	1.30	1.50	1.10	--	--
e	1.07	1.27	1.37	1.17	1.27	1.37
E4	3.52	3.72	3.92	3.34	3.44	3.54
L	0.36	0.66	0.76	0.51	0.61	0.71
L1	--	--	0.12	--	--	0.10
H	0.30	0.50	0.70	0.51	0.61	0.71

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- The instructions are subject to change without notice! Customers should obtain the latest relevant information before placing orders and should verify that such information is complete and current.
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Rev.: 1.7

Revision History:

1. Update Electrical schematic and typical test circuit
- 

Rev.: 1.6

Revision History:

1. Modify Electrical characteristics and curves
- 

Rev.: 1.5

Revision History:

1. Modify Electrical characteristics
- 

Rev.: 1.4

Revision History:

1. Add the package outline of PDFN-8-5X6X0.95-1.27
- 

Rev.: 1.3

Revision History:

1. Update the Electrical characteristics
  2. Update Fig 5 and 6
- 

Rev.: 1.2

Revision History:

1. Update the package outline of TO-220-3L
- 

Rev.: 1.1

Revision History:

1. Add TO-263-2L
- 

Rev.: 1.0

Revision History:

1. First release
-